

Guru Gobind Singh Indraprastha University, Delhi

A0171732

CONSOLIDATED STATEMENT OF MARKS

0136109

BACHELOR OF TECHNOLOGY (ELECTRONICS AND COMMUNICATIONS ENGINEERING)

NAME: ENROLLMENT: SUDHANSHU CHIB

FATHER'S NAME:

SATISH KUMAR CHIB

YEAR OF ADMISSION:

2004

UNIVERSITY SCHOOL/INSTITUTE: AMITY SCHOOL OF ENGINEERING & TECHNOLOGY

0731042804

TOTAL CREDIT OF PROGRAMME: 214

MINIMUM CREDITS REQUIRED: 200

YEAR OF COMPLETION:

MAY, 2008

PROGRAMME DURATION:

08 SEMESTERS



PROPERTY PROPERTY	CODE	PAPER	CS	INT	EXT	TOTAL	CODE	PAPER	cs	INT	EXT	тот/
PROPERTY PROPERTY						FIRST SE	MESTER					
TELLIS SYMMODUCTION TO COMPUTERD AND AUTO CAD 3 17 29 35 31 4 37 4 37 4 37 4 37 4 37 4 38 38	TMA101	APPLIED MATHEMATICS - I	4	21	38	59	ETPH103	APPLIED PHYSICS - I	3	17	45	62
Page	TCH105	APPLIED CHEMISTRY - I	3	19	42	61	ETME107	MANUFACTURING PROCESS	2	17	47	64
Page	TCS109	INTRODUCTION TO COMPUTERS AND AUTO CAD	3	17	58	75	ETEL111	COMMUNICATION SKILLS - I	3	17	37	54
March Monch Monc	TEL113	IMPACT OF SCIENCE & TECHNOLOGY ON SOCIETY	1	-	77	77	ETPH151	APPLIED PHYSICS LAB - I	10	32	55	87
STATE	TCH153	APPLIED CHEMISTRY LAB - I		34	57	91	ETCS155		2	36	48	84
TRACE APPLIED MATHEMATICS	TME157	WORKSHOP PRACTICE	2	35	48	83	ETME159	ENGINEERING GRAPHICS LAB	71	28	42	70
Triangle Papules Chemistry F 1						SECOND S	EMESTER					
MINISTREE PROMINES MICHANICS 3 21 45 66	TMA102	APPLIED MATHEMATICS - II	4	20	48	68	ETPH104	APPLIED PHYSICS - II	3	15	45	60
TELLIF COMMUNICATION SKILLS - II	TCH106	APPLIED CHEMISTRY - II	3	16	57	73	ETCS108	INTRODUCTION TO PROGRAMMING	3	16	44	60
Comparison Com	TME110	ENGINEERING MECHANICS	3	21	45	66	ETEC112	ELECTRICAL SCIENCE	3	13	43	56
March Brownermo Michangs Lab. 2 34 99 13 ETECTO BLECTRICAL SCIENCE LAB 1 34 61	TEL114	COMMUNICATION SKILLS - II	3	14	39	53	ETPH152	APPLIED PHYSICS LAB - II		38	55	9:
March Senoneerina Mechanics Lais	TCH154	APPLIED CHEMISTRY LAB - II	1	37	56	93	ETCS156	C PROGRAMMING LAB		32	50	8
THIRD SENSTER THIRD SENSTER 4 17 29 50 EFEC203 SIGNAL AND SYSTEM 4 21 24 24 24 24 24 24			1 2	34	59	93					Established A	8
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TECS20 CIRCUITS & SYSTEMS	MΔ201	APPLIED MATHEMATICS - III	1.	17	20	4		SIGNAL AND SYSTEM		94	F 52	
TITZEN OBJECT ORBINTED PROGRAMMING USING C++ LAB						+						5
EC219 ANALOG ELECTRONIOS - I LAB 1 33 52 85				200000000000000000000000000000000000000						-	1	6
1 33 51 84 ETC\$257 DATA STRUCTURE LAB 1 34 46												7
FORTITISEMESTER	TEC251	ANALOG ELECTRONICS - I LAB	1	33	52	85	ETEG253	CIRCUITS & SYSTEMS LAB	1	36	51	8
TEC202 SOFTWARE ENGINEERING	TIT255	OBJECT ORIENTED PROGRAMMING USING C++ LAB	1	33	51			DATA STRUCTURE LAB	1	34	48	8
						FOURTH S	EMESTER					
EC210 ELECTROMAGNETICS FIELDS & TRANSMISSION 4 11 47 58	rCS202	SOFTWARE ENGINEERING	4	17	54	71	ETEC204	ANALOG ELECTRONICS - II	4	20	43	6
LINES	FEC206	DIGITAL CIRCUITS & SYSTEM - I	4	22	36	58	ETEC208	COMMUNICATION SYSTEMS & CIRCUITS - I	4	19	51	7
TCS252 SOFTWARE ENGINEERING LAB	TEC210		4	11	47	58	ETCS212	OPERATING SYSTEMS	4	19	42	6
TEC301 DIGITAL CIRCUITS & SYSTEMS - II	TCS252		1	35	38	73	ETEC254	ANALOG ELECTRONICS - II LAB	11	36	52	8
EC391 DIGITAL CIRCUITS & SYSTEMS - II	TEC256	DIGITAL CIRCUITS & SYSTEMS - I LAB	1	34	48	82	ETEC258	COMMUNICATION SYSTEMS & CIRCUITS - I LAB	1	32	45	7
TCS305 COMPUTER ARCHITECTURE						FIFTH SI	MESTER					
Tecasis Digital circuits & systems	TEC301	DIGITAL CIRCUITS & SYSTEMS - II	4	18	38	56	ETEC303	CONTROL ENGINEERING	4	16	41	5
Tecasian Data Base Management systems	TCS305	COMPUTER ARCHITECTURE	4	18	38	56	ETEC307	COMMUNICATION SYSTEM & CIRCUITS - II	4	19	35	5
TEC351 DIGITAL CIRCUITS & SYSTEMS - II LAB			4	-	41							5
TEC355 COMMUNICATION SYSTEM & CIRCUITS - II LAB					5,9 KO V (1)			The state of the s				6 mm m
TEC359 PRACTICAL TRAINING												8
SIXTH SEMESTER					Secretary of the second		L E108357	DATA DASE MANAGEMENT SYSTEMS LAB.	1 1	33	1 49	8
TEC302 MICROWAVE ENGINEERING	126359	PRACHOAL I KAINING	1 1		86		MESTER					
TIT1306 COMPUTER NETWORKS	TEC302	MICROWAVE ENGINEERING	4	16	50	T		MICROPROCESSOR SYSTEMS - I	a	15	42	5
TEC310 TELECOMMUNICATION NETWORKS			_		wa samen.			1	14			6
TEC352 MICROWAVE ENGINEERING LAB. 1 28 38 66 ETEC354 MICROPROCESSOR SYSTEMS - I LAB 1 30 50						-		DIGITAL SIGNAL PROCESSING AND ITS				6
TEC360 DIGITAL SIGNAL PROCESSING AND ITS 1 31 50 81	TEC352	MICROWAVE ENGINEERING LAB.	11	28	38	66	ETEC354		11	30	50	8
SEVENTH SEMESTER	TEC356	VLSI DESIGN LAB	1	30	48	78	ETEC358	TELECOMMUNICATION NETWORKS LAB	1	24	47	7
SEVENTH SEMESTER			1	31	50	81						
TEC401 MICROPROCESSOR SYSTEMS - II 4 13 40 53 ETEC403 OPTICAL COMMUNICATION 4 19 39 TEC407 MOBILE COMPUTING 4 11 40 51 ETEC409 ADVANCED VLSI DESIGN 4 15 39 TEC451 MICROPROCESSOR SYSTEMS - II LAB 1 26 45 71 ETEC453 OPTICAL COMMUNICATION LAB 1 29 40			1			SEVENTH	SEMESTER					
TEC407 MOBILE COMPUTING 4 11 40 51 ETEC409 ADVANCED VLSI DESIGN 4 15 39 TEC451 MICROPROCESSOR SYSTEMS - II LAB 1 26 45 71 ETEC453 OPTICAL COMMUNICATION LAB 1 29 40	TEC401	MICROPROCESSOR SYSTEMS - II	4	13	40	1		OPTICAL COMMUNICATION	4	19	39	51
TEC451 MICROPROCESSOR SYSTEMS - II LAB 1 26 45 71 ETEC453 OPTICAL COMMUNICATION LAB 1 29 40					1							5
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1 30 46 78 E1EC457 SEMINAR 1 - 73						+						
TEC459 MINOR PROJECT 4 22 50 72 ETEC461 PRACTICAL TRAINING 1 - 73	1 to 1 to 2 to 1	PRACTICALS (BASED ON ELECTIVES)	_11	30	48	1 /8	E1EC457	SEMINAK	1	-	1 73	7.